



# HYX65H1K0RH Series

HYF65H1K0RH / HYE65H1K0RH / HYL65H1K0RH  
 HYD65H1K0RH / HYP65H1K0RH / HYI65H1K0RH

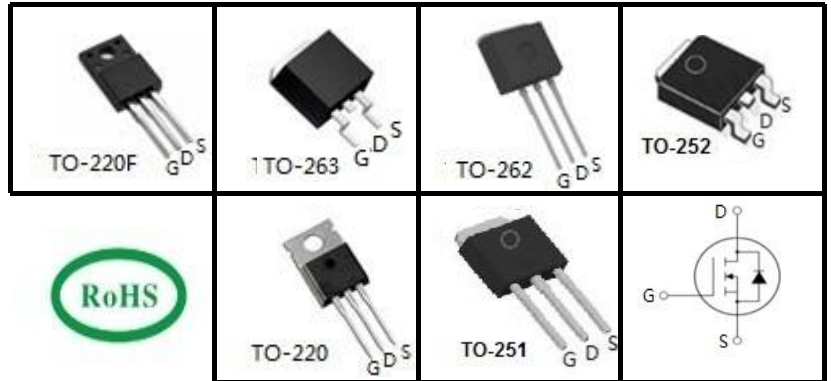
## 650V Super-Junction Power MOSFET

### FEATURES

- Very low FOM  $R_{DS(on)} \times Q_g$
- 100% avalanche tested
- RoHS compliant

### APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



Device Marking and Package Information						
Device	HYF65H1K0RH	HYE65H1K0RH	HYL65H1K0RH	HYD65H1K0RH	HYP65H1K0RH	HYI65H1K0RH
Package	TO-220F	TO-263	TO-262	TO-252	TO-220	TO-251
Marking	HYF65H1K0RH	HYE65H1K0RH	HY65H1K0RH	HYD65H1K0RH	HYP65H1K0RH	HYI65H1K0RH

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ , unless otherwise noted				
Parameter	Symbol	Value		Unit
		TO-220, TO-251, TO-252 TO-262, TO-263	TO-220F	
Drain-Source Voltage ( $V_{GS} = 0V$ )	$V_{DSS}$	650		V
Continuous Drain Current	$I_D$	$T_C = 25^\circ\text{C}$	4	A
		$T_C = 100^\circ\text{C}$	2.4	
Pulsed Drain Current (note1)	$I_{DM}$	12		A
Gate-Source Voltage	$V_{GSS}$	$\pm 30$		V
Single Pulse Avalanche Energy (note2)	$E_{AS}$	52.8		mJ
Avalanche Current (note1)	$I_{AS}$	0.8		A
MOSFET dv/dt ruggedness, $V_{DS} = 0 \dots 480V$	dv/dt	50		V/ns
Reverse diode dv/dt, $V_{DS} = 0 \dots 480V$ , $I_{SD} \leq I_D$	dv/dt	15		V/ns
Power Dissipation ( $T_C = 25^\circ\text{C}$ )	$P_D$	28	23	W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55~+150		$^\circ\text{C}$

Thermal Resistance				
Parameter	Symbol	Value		Unit
		TO-220, TO-251, TO-252 TO-262, TO-263	TO-220F	



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Thermal Resistance, Junction-to-Case	$R_{thJC}$	4.4	5.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	62	80	

## Specifications $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	650	--	--	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 650V, V_{GS} = 0V, T_J = 25^\circ\text{C}$	--	--	1	$\mu A$
		$V_{DS} = 650V, V_{GS} = 0V, T_J = 150^\circ\text{C}$	--	--	100	
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 30V$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.5	--	4.0	V
Drain-Source On-Resistance (Note3)	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 1A$	--	0.88	1.0	$\Omega$
Forward Transconductance (Note3)	$g_{fs}$	$V_{DS} = 10V, I_D = 1A$	--	3	--	S
<b>Dynamic</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V,$ $V_{DS} = 50V,$ $f = 1.0\text{MHz}$	--	360	--	pF
Output Capacitance	$C_{oss}$		--	23	--	
Reverse Transfer Capacitance	$C_{rss}$		--	2.8	--	
Total Gate Charge	$Q_g$	$V_{DD} = 520V, I_D = 4A,$ $V_{GS} = 10V$	--	7	--	nC
Gate-Source Charge	$Q_{gs}$		--	1.5	--	
Gate-Drain Charge	$Q_{gd}$		--	2.5	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 400V, I_D = 4A,$ $R_G = 25\Omega$	--	36	--	ns
Turn-on Rise Time	$t_r$		--	27	--	
Turn-off Delay Time	$t_{d(off)}$		--	79	--	
Turn-off Fall Time	$t_f$		--	29	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$	$T_C = 25^\circ\text{C}$	--	--	4	A
Pulsed Diode Forward Current	$I_{SM}$		--	--	12	
Body Diode Voltage	$V_{SD}$	$T_J = 25^\circ\text{C}, I_{SD} = 4A, V_{GS} = 0V$	--	0.9	1.2	V
Reverse Recovery Time	$t_{rr}$	$V_R = 480V, I_F = I_S,$ $diF/dt = 100A/\mu s$	--	220	--	ns
Reverse Recovery Charge	$Q_{rr}$		--	0.9	--	$\mu C$
Peak Reverse Recovery Current	$I_{rrm}$		--	8	--	A

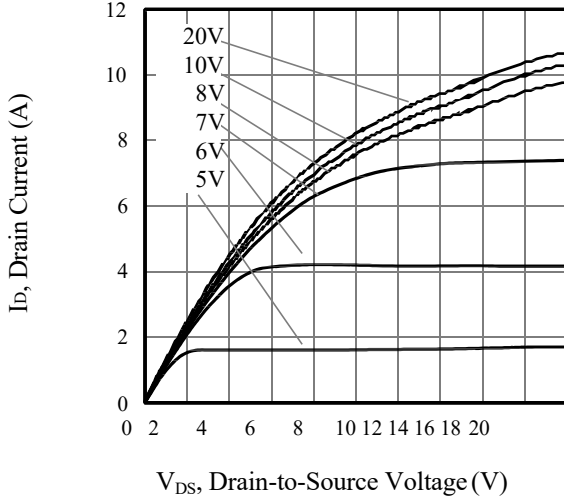
### Notes

1. Repetitive Rating: Pulse Width limited by maximum junction temperature
2.  $I_{AS} = 0.8A, V_{DD} = 50V, R_G = 25\Omega, \text{Starting } T_J = 25^\circ\text{C}$
3. Pulse Test: Pulse Width  $\leq 300\mu s, \text{Duty Cycle } \leq 1\%$

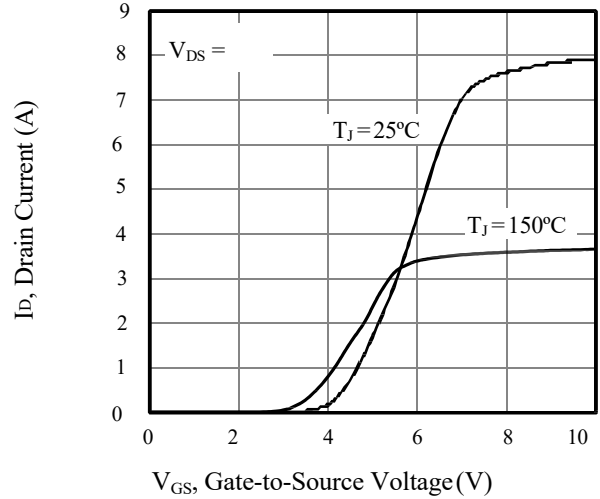


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

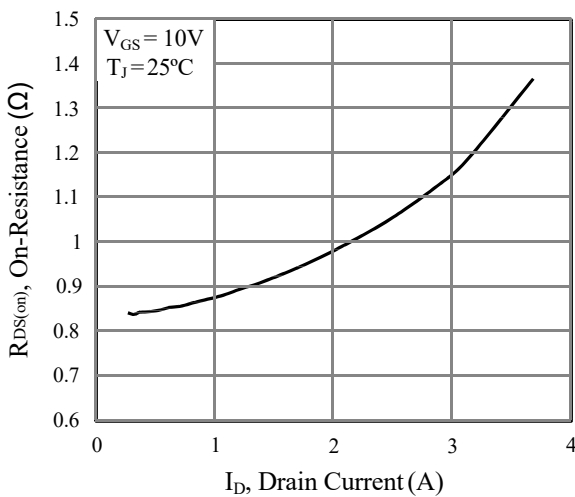
**Figure 1. Output Characteristics**



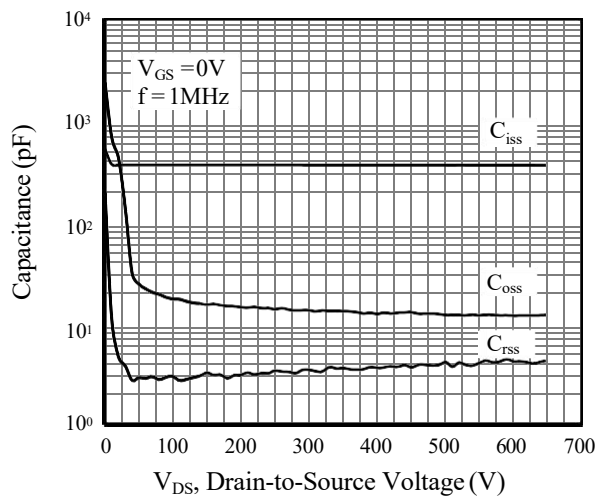
**Figure 2. Transfer Characteristics**



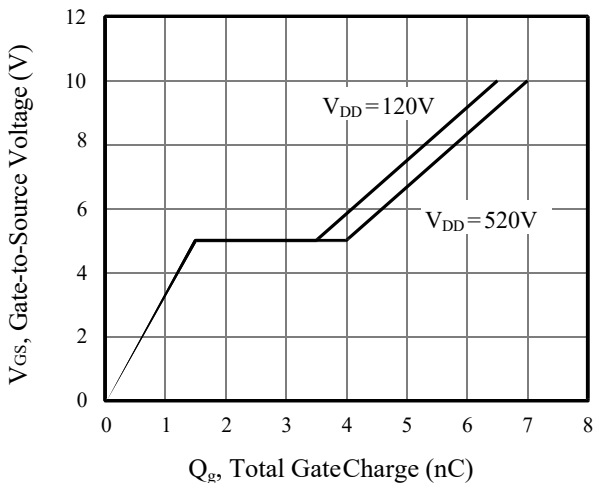
**Figure 3. On-Resistance vs. Drain Current**



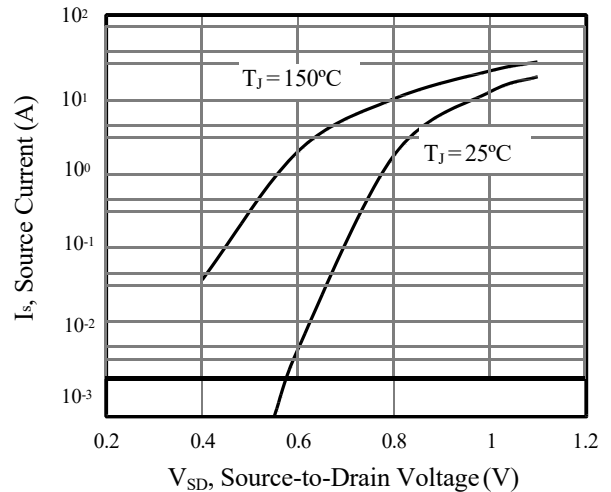
**Figure 4. Capacitance**



**Figure 5. Gate Charge**



**Figure 6. Body Diode Forward Voltage**





Typical Characteristics  $T_j = 25^\circ\text{C}$ , unless otherwise noted

Figure 7. On-Resistance vs.

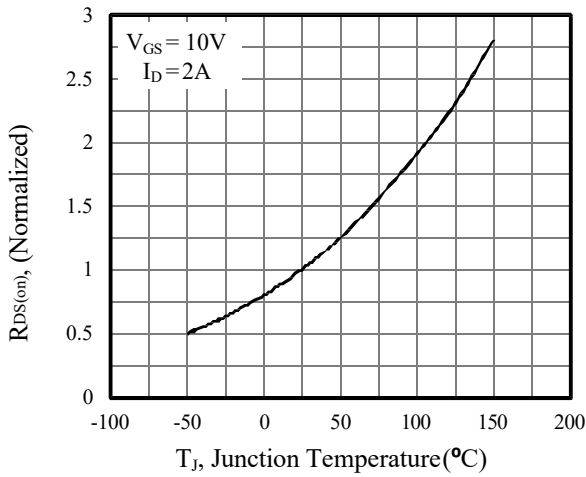


Figure 8. Threshold Voltage vs.

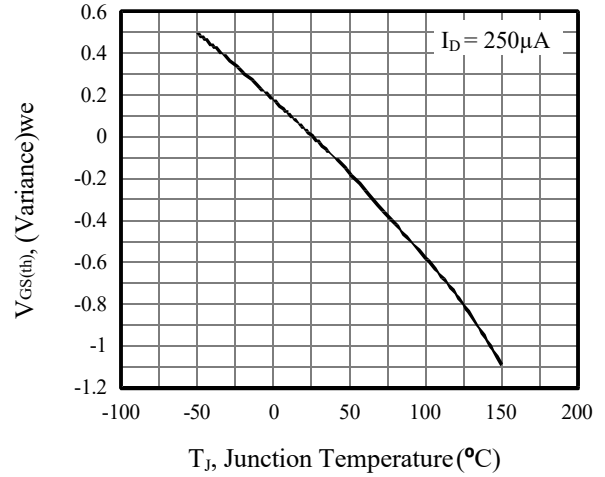
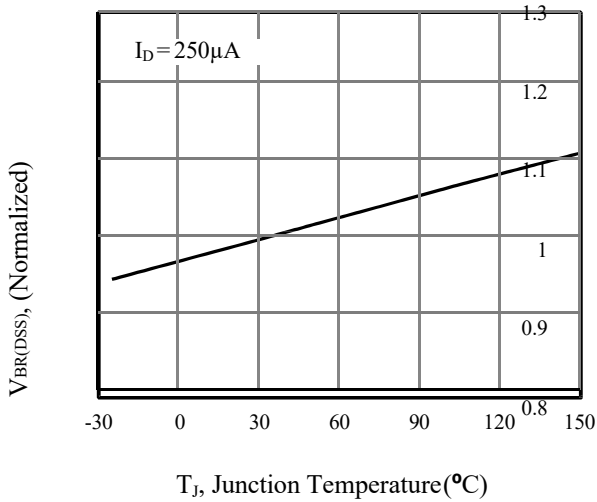


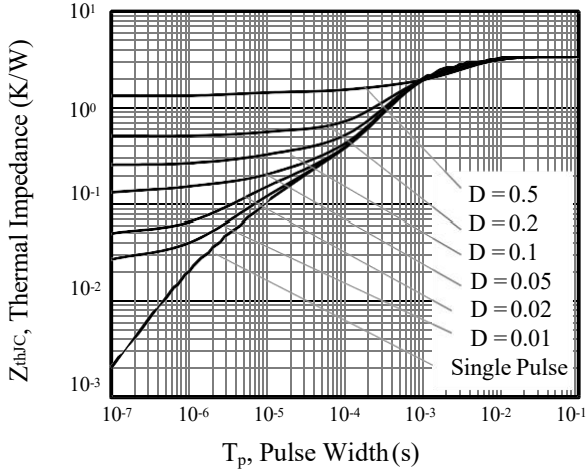
Figure 9. Breakdown voltage vs. Junction Temperature



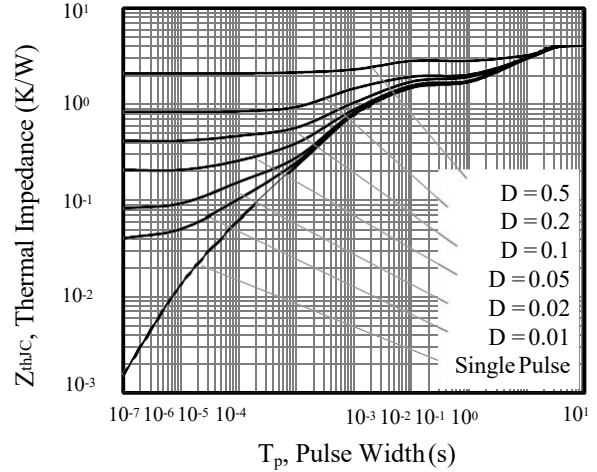


### Typical Characteristics $T_J = 25^\circ\text{C}$ , unless otherwise noted

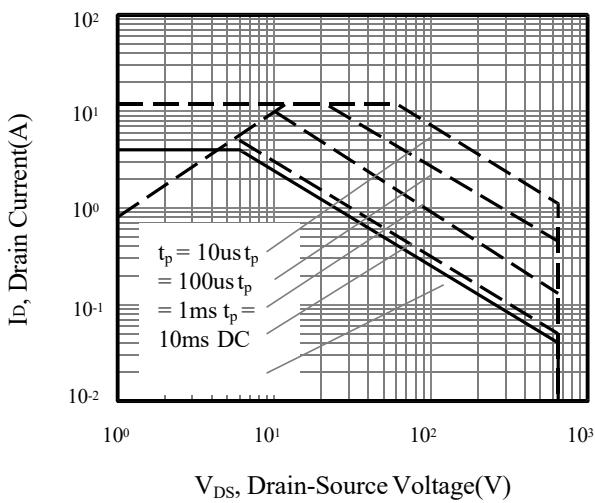
**Figure 10. Transient Thermal Impedance TO-220, TO-251, TO-252, TO-262, TO-263**



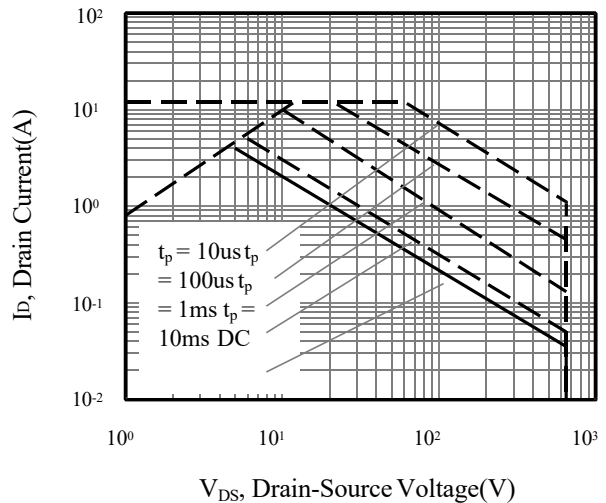
**Figure 11. Transient Thermal Impedance TO-220F**



**Figure 12. Safe operation area for TO-220, TO-251, TO-252, TO-262, TO-263**



**Figure 13. Safe operation area for TO-220F**

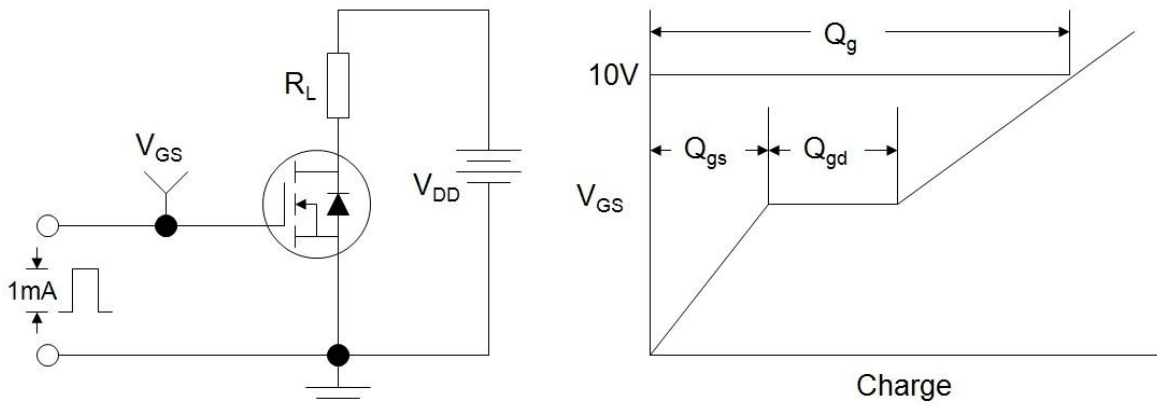




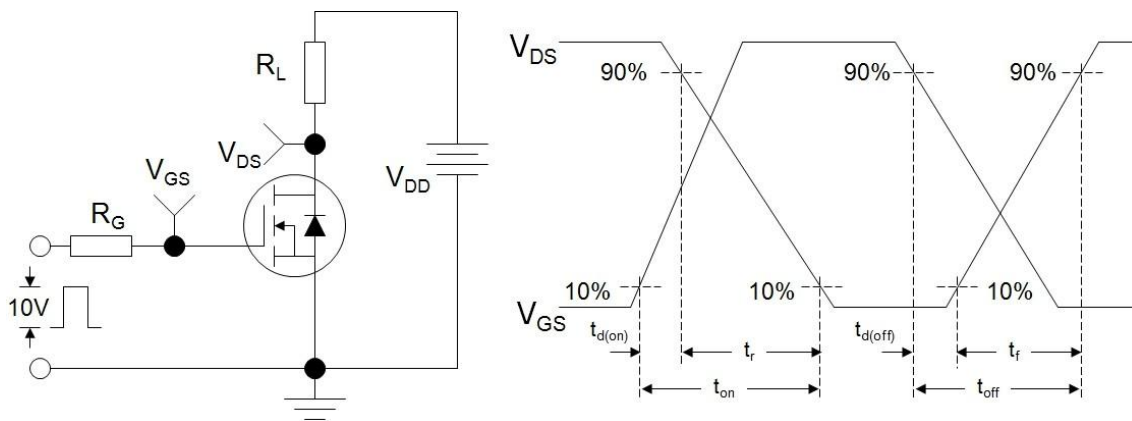
# HYX65H1K0RH Multi-Series Package

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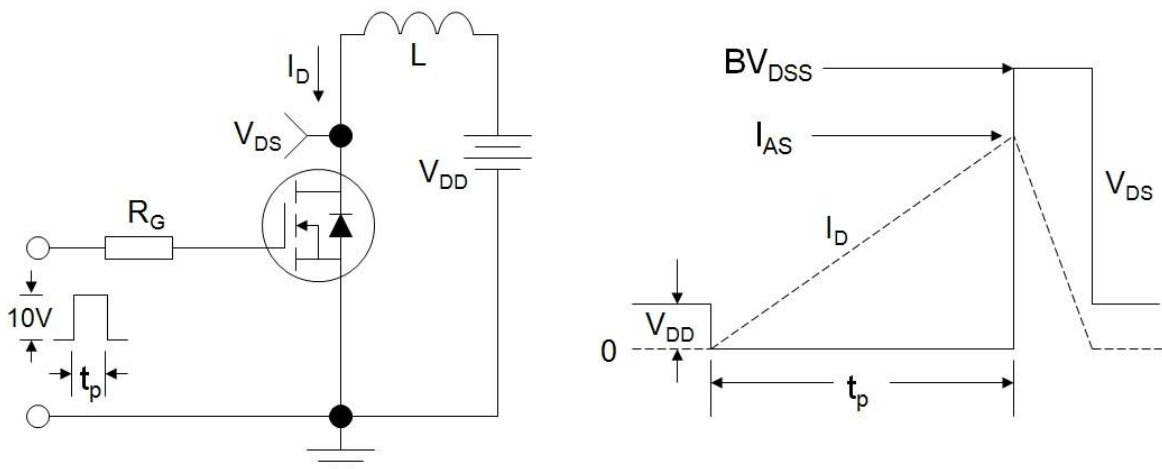
**Figure A: Gate Charge Test Circuit and Waveform**



**Figure B: Resistive Switching Test Circuit and Waveform**



**Figure C: Unclamped Inductive Switching Test Circuit and Waveform**

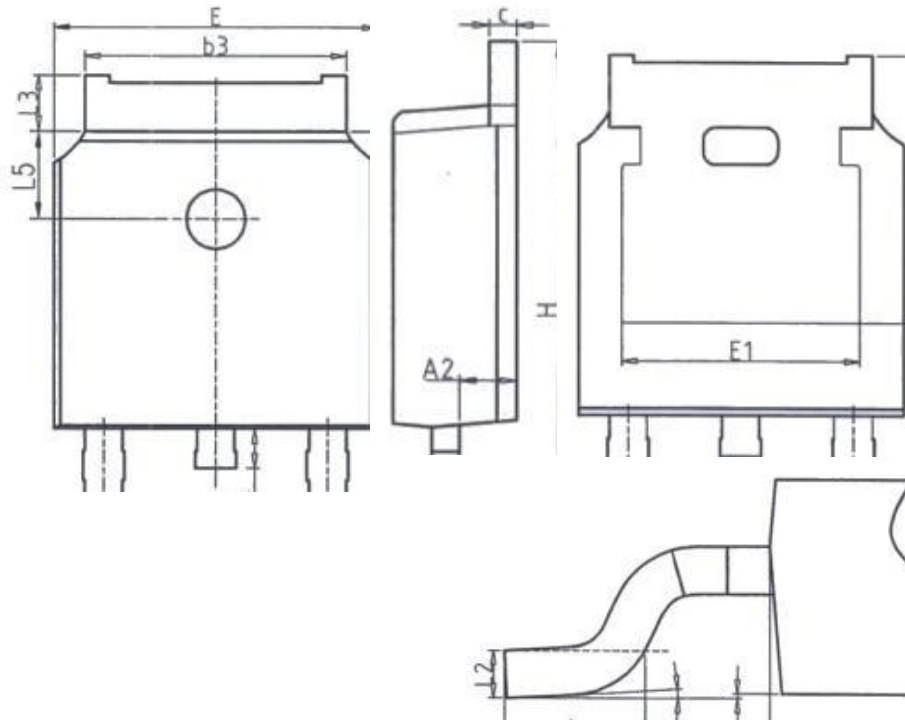




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## TO-252



Unit: mm		
Symbol	Min.	Max.
A	2.20	2.40
A1	0.00	0.20
A2	0.97	1.17
b	0.68	0.90
b3	5.20	5.50
c	0.43	0.63
D	5.98	6.22
D1	5.30REF	
E	6.40	6.80
E1	4.63	-

Unit: mm		
Symbol	Min.	Max.
e	2.286BSC	
H	9.40	10.50
L	1.38	1.75
L1	2.90REF	
L2	0.51BSC	
L3	0.88	1.28
L4	-	1.00
L5	1.65	1.95
θ	0°	8°